



ICS879511

LOW SKEW, 1-TO-9 DIFFERENTIAL-TO-LVCMOS/LVTTL ZERO DELAY BUFFER

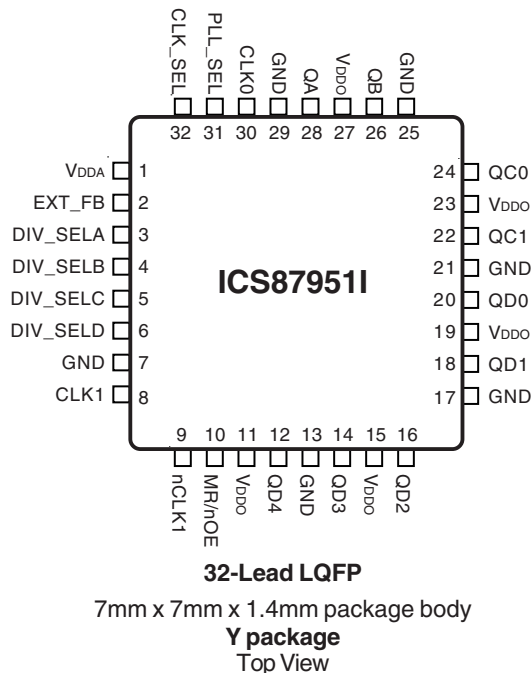
GENERAL DESCRIPTION

The ICS879511 is a low voltage, low skew 1-to-9 Differential-to-LVCMOS/LVTTL Clock Generator. The ICS879511 has two selectable clock inputs. The single ended clock input accepts LVCMOS or LVTTL input levels. The CLK1, nCLK1 pair can accept most standard differential input levels. With output frequencies up to 180MHz, the ICS879511 is targeted for high performance clock applications. Along with a fully integrated PLL, the ICS879511 contains frequency configurable outputs and an external feedback input for regenerating clocks with “zero delay”.

FEATURES

- Fully integrated PLL
- Nine single ended 3.3V LVCMOS/LVTTL outputs
- Selectable single ended CLK0 or differential CLK1, nCLK1 inputs
- The single ended CLK0 input can accept the following input levels: LVCMOS or LVTTL input levels
- CLK1, nCLK1 supports the following input types: LVDS, LVPECL, LVHSTL, SSTL, HCSL
- Output frequency range: 25MHz to 180MHz
- VCO range: 200MHz to 480MHz
- External feedback for “zero delay” clock regeneration
- Cycle-to-cycle jitter: $\pm 100\text{ps}$ (typical)
- Output skew: 375ps (maximum)
- PLL reference zero delay: 350ps window (maximum)
- 3.3V operating supply
- -40°C to 85°C ambient operating temperature
- Available in both standard and lead-free RoHS-compliant packages

PIN ASSIGNMENT

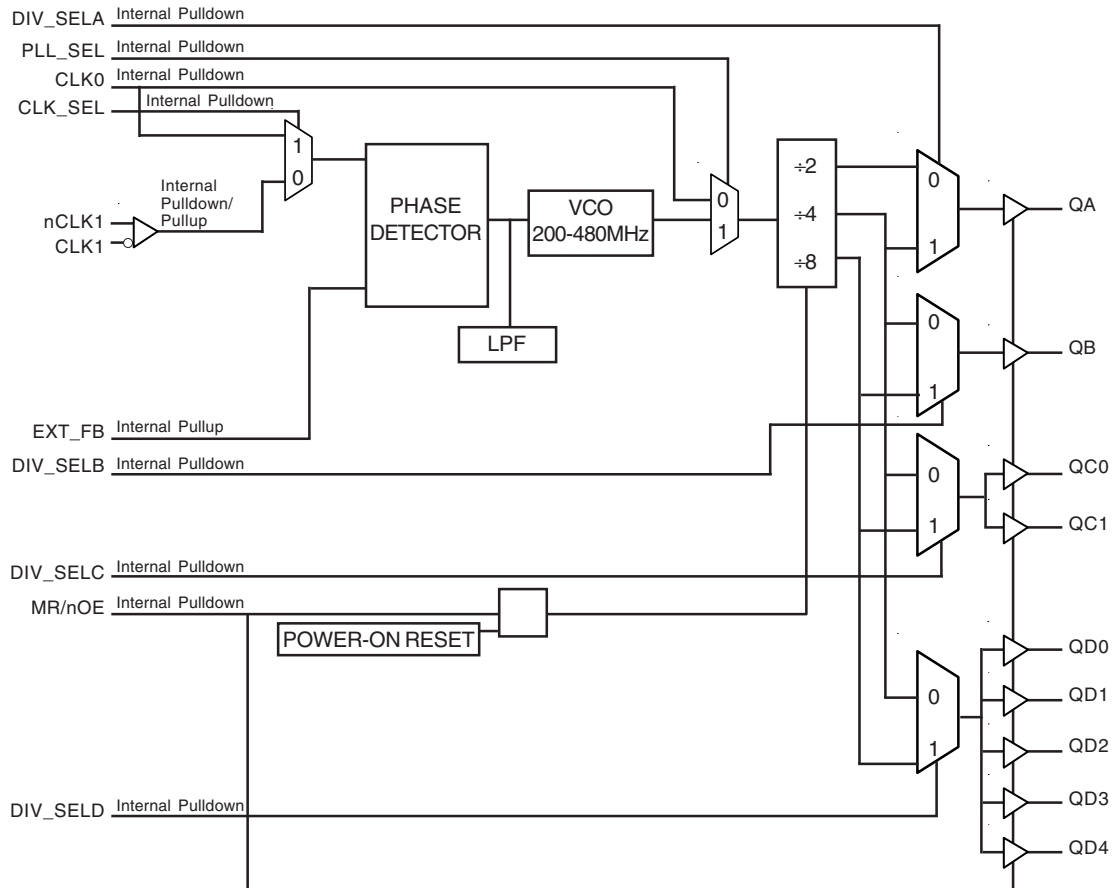




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BLOCK DIAGRAM





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TABLE 1. PIN DESCRIPTIONS

| Number | Name | Type | | Description |
|-----------------------|-------------------------|--------|----------|--|
| 1 | V _{DDA} | Power | | Analog supply pin. |
| 2 | EXT_FB | Input | Pullup | Feedback input to phase detector for regenerating clocks with "zero delay". LVCMOS / LVTTL interface levels. |
| 3 | DIV_SELA | Input | Pulldown | Selects divide value for Bank A output as described in Table 3D. LVCMOS / LVTTL interface levels. |
| 4 | DIV_SELB | Input | Pulldown | Selects divide value for Bank B output as described in Table 3D. LVCMOS / LVTTL interface levels. |
| 5 | DIV_SELC | Input | Pulldown | Selects divide value for Bank C outputs as described in Table 3D. LVCMOS / LVTTL interface levels. |
| 6 | DIV_SELD | Input | Pulldown | Selects divide value for Bank D outputs as described in Table 3D. LVCMOS / LVTTL interface levels. |
| 7, 13, 17, 21, 25, 29 | GND | Power | | Power supply ground. |
| 8 | CLK1 | Input | Pullup | Non-inverting differential clock input. |
| 9 | nCLK1 | Input | Pulldown | Inverting differential clock input. |
| 10 | MR/nOE | Input | Pulldown | Active HIGH Master Reset. Active LOW output enable. When logic HIGH, the internal dividers are reset and the outputs are tri-stated (HiZ). When logic LOW, the internal dividers and the outputs are enabled. LVCMOS / LVTTL interface levels. |
| 11, 15, 19, 23, 27 | V _{DDO} | Power | | Output supply pins. |
| 12, 14, 16, 18, 20 | QD4, QD3, QD2, QD1, QD0 | Output | | Bank D clock outputs. 7Ω typical output impedance. LVCMOS / LVTTL interface levels. |
| 22, 24 | QC1, QC0 | Output | | Bank C clock outputs. 7Ω typical output impedance. LVCMOS / LVTTL interface levels. |
| 26 | QB | Output | | Bank B clock output. 7Ω typical output impedance. LVCMOS / LVTTL interface levels. |
| 28 | QA | Output | | Bank A clock output. 7Ω typical output impedance. LVCMOS / LVTTL interface levels. |
| 30 | CLK0 | Input | Pulldown | LVCMOS / LVTTL phase detector reference clock input. |
| 31 | PLL_SEL | Input | Pulldown | Selects between the PLL and the reference clock as the input to the dividers. When HIGH, selects PLL. When LOW, selects the reference clock. LVCMOS / LVTTL interface levels. |
| 32 | CLK_SEL | Input | Pulldown | Clock select input. When HIGH, selects CLK0. When LOW, selects CLK1, nCLK1. LVCMOS / LVTTL interface levels. |

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------------------|--|---|---------|---------|---------|-------|
| C _{IN} | Input Capacitance | | | 4 | | pF |
| C _{PD} | Power Dissipation Capacitance (per output) | V _{DDA} , V _{DDO} = 3.47V | | 25 | | pF |
| R _{PULLUP} | Input Pullup Resistor | | | 51 | | KΩ |
| R _{PULLDOWN} | Input Pulldown Resistor | | | 51 | | KΩ |
| R _{OUT} | Output Impedance | | 5 | 7 | 12 | Ω |



TABLE 3A. OUTPUT CONTROL PIN FUNCTION TABLE

| Inputs | Outputs | | | |
|--------|---------|---------|----------|---------|
| MR/nOE | QA | QB | QC0, QC1 | QD0:QD4 |
| 1 | HiZ | HiZ | HiZ | HiZ |
| 0 | Enabled | Enabled | Enabled | Enabled |

TABLE 3B. OPERATING MODE FUNCTION TABLE

| Inputs | Operating Mode |
|---------|----------------|
| PLL_SEL | |
| 0 | Bypass |
| 1 | PLL |

TABLE 3C. PLL INPUT FUNCTION TABLE

| Inputs | |
|---------|-------------|
| CLK_SEL | PLL Input |
| 0 | CLK1, nCLK1 |
| 1 | CLK0 |

TABLE 3D. PROGRAMMABLE OUTPUT FREQUENCY FUNCTION TABLE

| Inputs | | | | Outputs | | | |
|----------|----------|-----------|----------|---------|-------|-------|-------|
| DIV_SELA | DIV SELB | DIV_SEL C | DIV SELD | QA | QB | QCx | QDx |
| 0 | 0 | 0 | 0 | VCO/2 | VCO/4 | VCO/4 | VCO/4 |
| 0 | 0 | 0 | 1 | VCO/2 | VCO/4 | VCO/4 | VCO/8 |
| 0 | 0 | 1 | 0 | VCO/2 | VCO/4 | VCO/8 | VCO/4 |
| 0 | 0 | 1 | 1 | VCO/2 | VCO/4 | VCO/8 | VCO/8 |
| 0 | 1 | 0 | 0 | VCO/2 | VCO/8 | VCO/4 | VCO/4 |
| 0 | 1 | 0 | 1 | VCO/2 | VCO/8 | VCO/4 | VCO/8 |
| 0 | 1 | 1 | 0 | VCO/2 | VCO/8 | VCO/8 | VCO/4 |
| 0 | 1 | 1 | 1 | VCO/2 | VCO/8 | VCO/8 | VCO/8 |
| 1 | 0 | 0 | 0 | VCO/4 | VCO/4 | VCO/4 | VCO/4 |
| 1 | 0 | 0 | 1 | VCO/4 | VCO/4 | VCO/4 | VCO/8 |
| 1 | 0 | 1 | 0 | VCO/4 | VCO/4 | VCO/8 | VCO/4 |
| 1 | 0 | 1 | 1 | VCO/4 | VCO/4 | VCO/8 | VCO/8 |
| 1 | 1 | 0 | 0 | VCO/4 | VCO/8 | VCO/4 | VCO/4 |
| 1 | 1 | 0 | 1 | VCO/4 | VCO/8 | VCO/4 | VCO/8 |
| 1 | 1 | 1 | 0 | VCO/4 | VCO/8 | VCO/8 | VCO/4 |
| 1 | 1 | 1 | 1 | VCO/4 | VCO/8 | VCO/8 | VCO/8 |



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ABSOLUTE MAXIMUM RATINGS

| | |
|--|---------------------------|
| Supply Voltage, V_{DD} | 4.6V |
| Inputs, V_I | -0.5V to $V_{DDA} + 0.5V$ |
| Outputs, V_O | -0.5V to $V_{DDO} + 0.5V$ |
| Package Thermal Impedance, θ_{JA} | 42.1°C/W (0 lfp/m) |
| Storage Temperature, T_{STG} | -65°C to 150°C |

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY DC CHARACTERISTICS, $V_{DDA} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ C$ TO $85^\circ C$

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------|-----------------------|-------------------|---------|---------|---------|-------|
| V_{DDA} | Analog Supply Voltage | | 3.135 | 3.3 | 3.465 | V |
| V_{DDO} | Output Supply Voltage | | 3.135 | 3.3 | 3.465 | V |
| I_{DDO} | Power Supply Current | All V_{DD} pins | | | 115 | mA |
| I_{DDA} | Analog Supply Current | | | | 20 | mA |

TABLE 4B. DC CHARACTERISTICS, $V_{DDA} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ C$ TO $85^\circ C$

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------|--------------------------------------|---|-----------|---------|-----------------|---------|
| V_{IH} | Input High Voltage | CLK0 | 2 | | $V_{DD} + 0.3$ | V |
| | | DIV_SELA:DIV_SELD, PLL_SEL, CLK_SEL, EXT_FB, MR/nOE | 2 | | $V_{DD} + 0.3$ | V |
| V_{IL} | Input Low Voltage | CLK0 | -0.3 | | 1.3 | V |
| | | DIV_SELA:DIV_SELD, PLL_SEL, CLK_SEL, EXT_FB, MR/nOE | -0.3 | | 0.8 | V |
| V_{PP} | Peak-to-Peak Input Voltage | CLK1, nCLK1 | 300 | | 1000 | mV |
| V_{CMR} | Common Mode Input Voltage; NOTE 1, 2 | | GND + 0.5 | | $V_{DD} - 0.85$ | V |
| V_{OH} | Output High Voltage | $I_{OH} = -40mA$ | 2.4 | | | V |
| V_{OL} | Output Low Voltage | $I_{OL} = 40mA$ | | | 0.5 | V |
| I_{IN} | Input Current | | | | ± 120 | μA |

NOTE 1: Common mode voltage is defined as V_{IH} .

NOTE 2: For single ended applications, the maximum input voltage for CLK1 and nCLK1 is $V_{DDA} + 0.3V$.



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TABLE 5. PLL INPUT REFERENCE CHARACTERISTICS, $V_{DDA} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ C$ TO $85^\circ C$

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------|---------------------------|-----------------|---------|---------|---------|-------|
| f_{REF} | Input Reference Frequency | | | | 100 | MHz |

TABLE 6. AC CHARACTERISTICS, $V_{DDA} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ C$ TO $85^\circ C$

| Symbol | Parameter | Test Conditions | Minimum | Typical | Maximum | Units |
|--------------------|-------------------------------|---|----------------------------------|-----------|-----------------|----------|
| f_{MAX} | Output Frequency | QA $\div 2$ | | | 180 | MHz |
| | | QA/QB $\div 4$ | | | 120 | MHz |
| | | QB $\div 8$ | | | 60 | MHz |
| f_{VCO} | PLL VCO Lock Range | | 200 | | 480 | MHz |
| $t(\emptyset)$ | Static Phase Offset; NOTE 1,3 | CLK0 | fREF = 50MHz Feedback = VCO/8 | 15 | 165 | ps |
| | | CLK1, nCLK1 | | -265 | -95 | ps |
| $t_{sk(o)}$ | Output Skew; NOTE 2, 3 | Same Frequencies | | | 375 | ps |
| | | Different Frequencies QAf _{MAX} < 150MHz QAf _{MAX} > 150MHz | | | 500 750 | ps ps |
| $f_{jit(cc)}$ | Cycle-to-Cycle Jitter; NOTE 3 | | | ± 100 | | ps |
| t_{LOCK} | PLL Lock Time; NOTE 3 | | | | 10 | mS |
| t_R | Output Rise Time | 0.8 to 2V | 0.1 | | 1.0 | ns |
| t_F | Output Fall Time | 0.8 to 2V | 0.1 | | 1.0 | ns |
| t_{PW} | Output Pulse Width | | tcycle/2 - 1000 | | tcycle/2 + 1000 | ps |
| t_{PZL} | Output Enable Time | | | | 6 | ns |
| t_{PLZ}, t_{PHZ} | Output Disable Time | | | | 7 | ns |

All parameters measured at f_{MAX} unless noted otherwise.

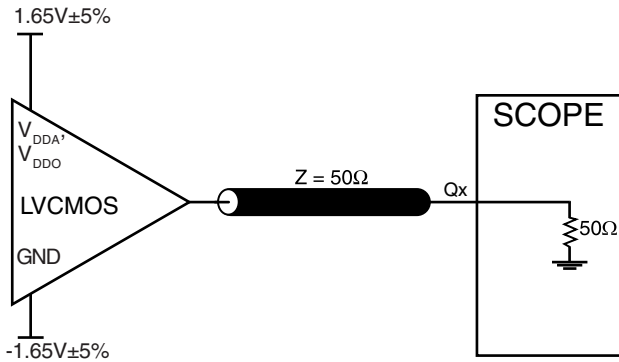
NOTE 1: Defined as the time difference between the input reference clock and the averaged feedback input signal, when the PLL is locked and the input reference frequency is stable.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.

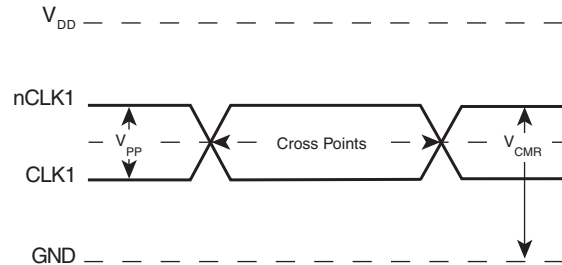
Measured at $V_{DDO}/2$.

NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

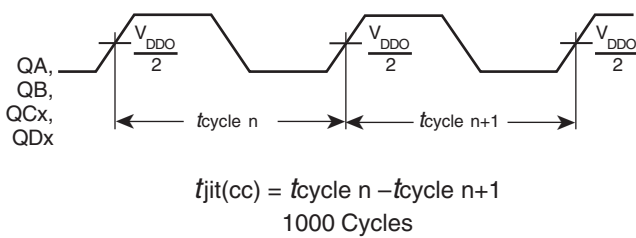
PARAMETER MEASUREMENT INFORMATION



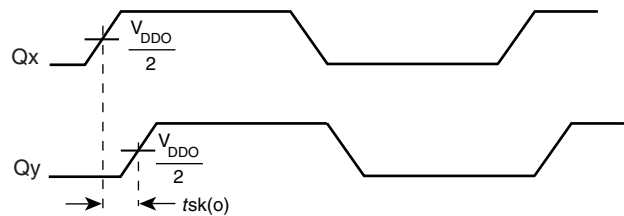
3.3V OUTPUT LOAD AC TEST CIRCUIT



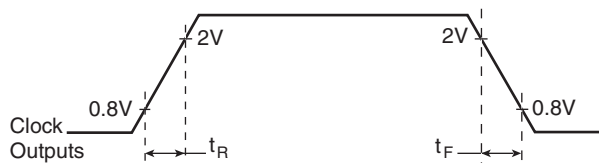
DIFFERENTIAL INPUT LEVEL



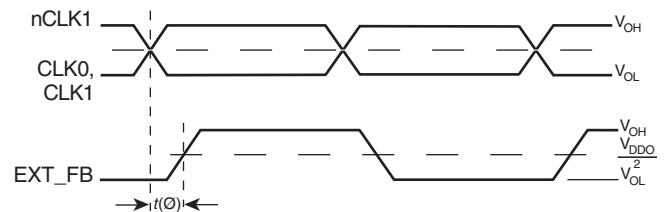
CYCLE-TO-CYCLE JITTER



OUTPUT SKEW



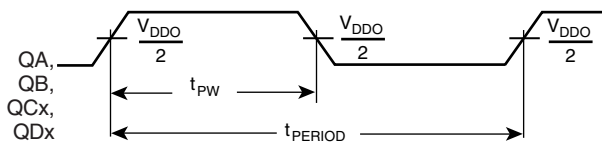
OUTPUT RISE/FALL TIME



$$t_{jit(\emptyset)} = |t(\emptyset) - t(\emptyset)_{mean}| = \text{Phase Jitter}$$

$$t(\emptyset)_{mean} = \text{Static Phase Offset}$$

(where $t(\emptyset)$ is any random sample, and $t(\emptyset)_{mean}$ is the average of the sampled cycles measured on controlled edges)



$$odc = \frac{t_{PW}}{t_{PERIOD}}$$

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

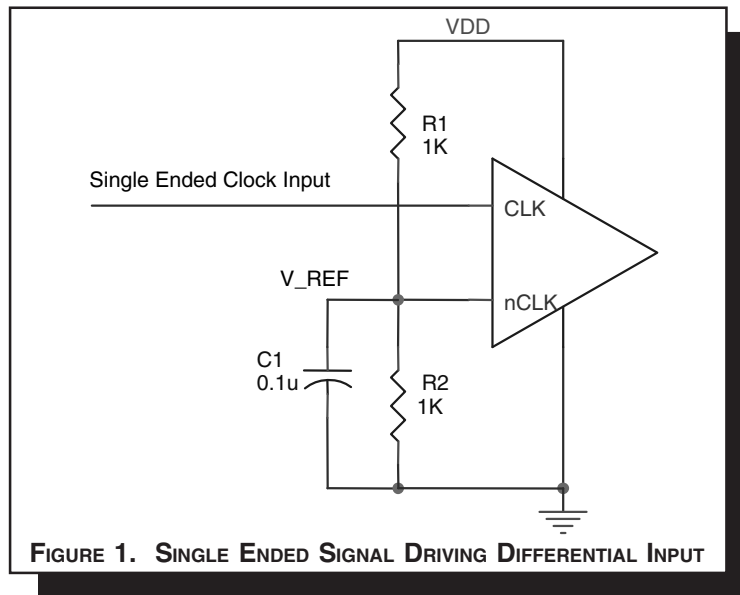
PHASE JITTER AND STATIC PHASE OFFSET

APPLICATION INFORMATION

WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 1 shows how the differential input can be wired to accept single ended levels. The reference voltage $V_{REF} \approx V_{DD}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio

of R1 and R2 might need to be adjusted to position the V_{REF} in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and $V_{DD} = 3.3V$, V_{REF} should be 1.25V and $R2/R1 = 0.609$.



POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS879511 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. V_{DDA} and V_{DDO} should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. Figure 2 illustrates how a 10Ω resistor along with a 10µF and a .01µF bypass capacitor should be connected to each V_{DDA} pin.

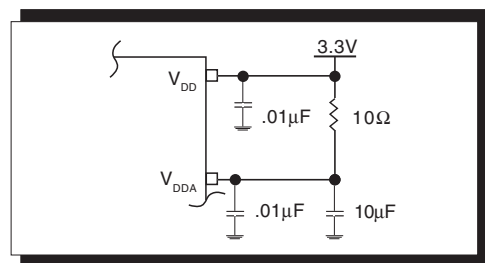


FIGURE 2. POWER SUPPLY FILTERING

DIFFERENTIAL CLOCK INPUT INTERFACE

The CLK1 /nCLK1 accepts LVDS, LVPECL, LVHSTL, SSTL, HCSL and other differential signals. Both V_{SWING} and V_{OH} must meet the V_{PP} and V_{CMR} input requirements. Figures 4A to 4D show interface examples for the CLK1/nCLK1 input driven by the most common driver types. The input interfaces suggested

here are examples only. Please consult with the vendor of the driver component to confirm the driver termination requirements. For example in *Figure 3A*, the input termination applies for LVHSTL drivers. If you are using an LVHSTL driver from another vendor, use their termination recommendation.

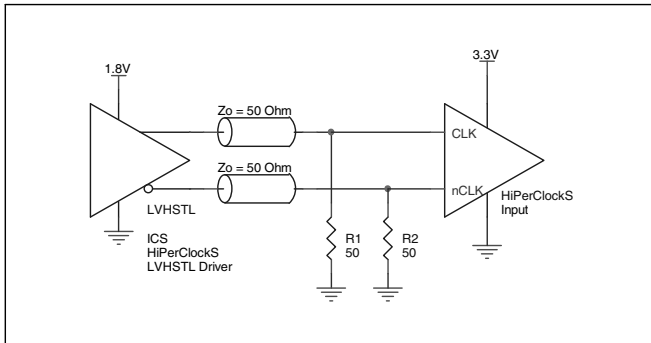


FIGURE 3A. CLK/nCLK INPUT DRIVEN BY LVHSTL DRIVER

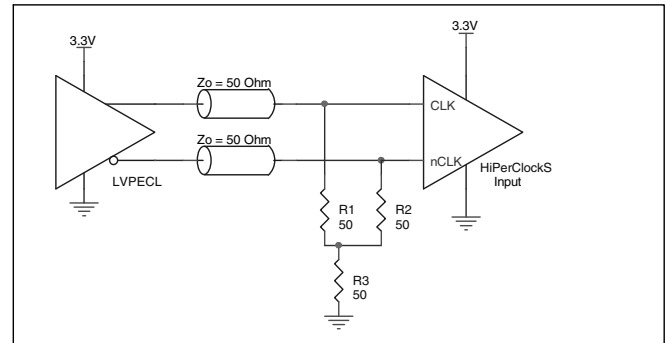


FIGURE 3B. CLK/nCLK INPUT DRIVEN BY 3.3V LVPECL DRIVER

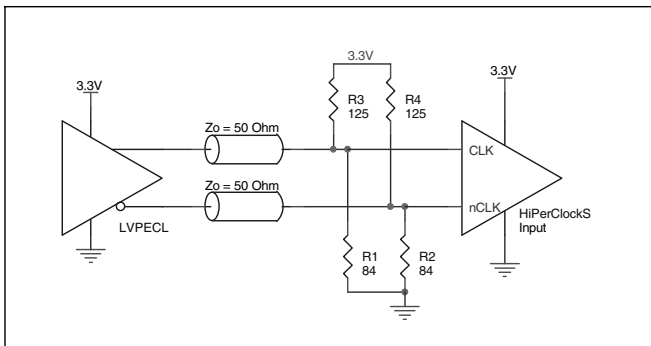


FIGURE 3C. CLK/nCLK INPUT DRIVEN BY 3.3V LVPECL DRIVER

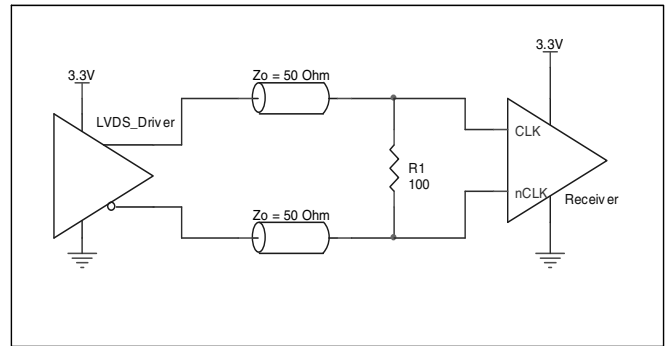


FIGURE 3D. CLK/nCLK INPUT DRIVEN BY 3.3V LVDS DRIVER

RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS:

CLK INPUT:

For applications not requiring the use of a clock input, it can be left floating. Though not required, but for additional protection, a 1k Ω resistor can be tied from the CLK input to ground.

CLK/nCLK INPUT:

For applications not requiring the use of the differential input, both CLK and nCLK can be left floating. Though not required, but for additional protection, a 1k Ω resistor can be tied from CLK to ground.

LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A 1k Ω resistor can be used.

OUTPUTS:

LVCMOS OUTPUT:

All unused LVCMOS output can be left floating. We recommend that there is no trace attached.



RELIABILITY INFORMATION

TABLE 7. θ_{JA} VS. AIR FLOW TABLE FOR 32 LEAD LQFP

| θ_{JA} by Velocity (Linear Feet per Minute) | | | |
|--|----------|----------|----------|
| | 0 | 200 | 500 |
| Single-Layer PCB, JEDEC Standard Test Boards | 67.8°C/W | 55.9°C/W | 50.1°C/W |
| Multi-Layer PCB, JEDEC Standard Test Boards | 47.9°C/W | 42.1°C/W | 39.4°C/W |

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS879511 is: 2674

PACKAGE OUTLINE - Y SUFFIX FOR 32 LEAD LQFP

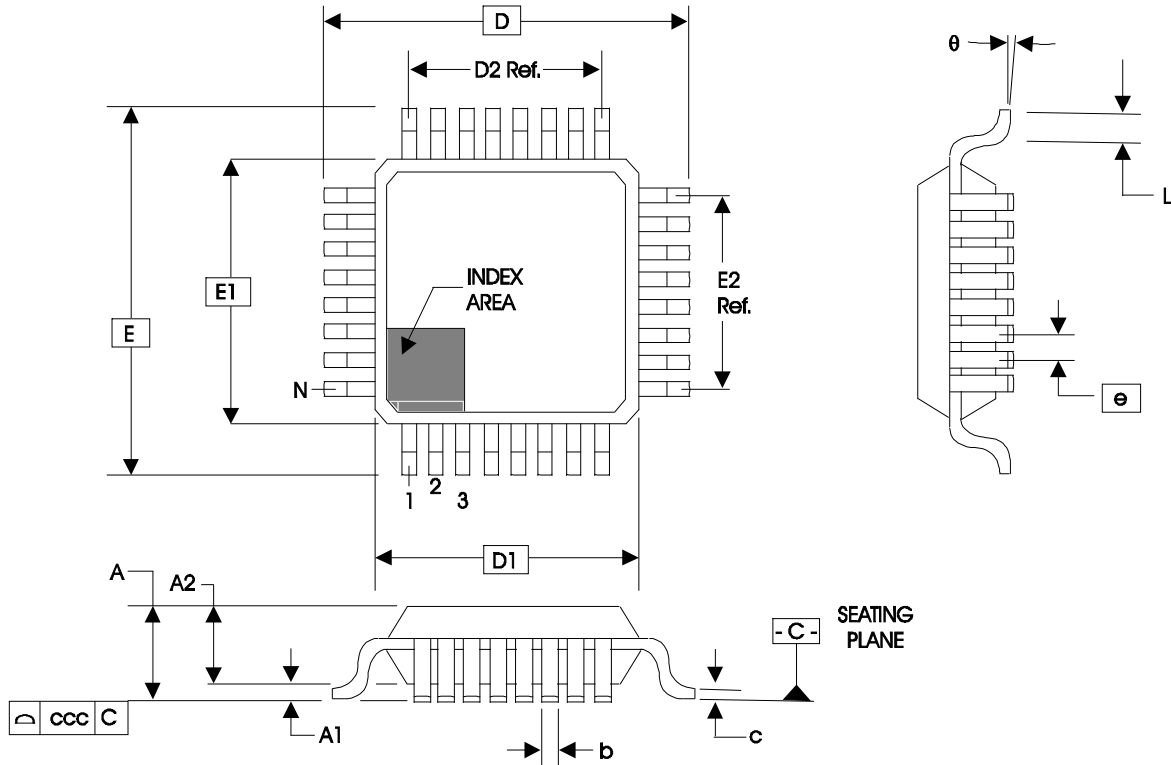


TABLE 8. PACKAGE DIMENSIONS

| JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS | | | |
|--|------------|---------|---------|
| SYMBOL | BBA | | |
| | MINIMUM | NOMINAL | MAXIMUM |
| N | 32 | | |
| A | -- | -- | 1.60 |
| A1 | 0.05 | -- | 0.15 |
| A2 | 1.35 | 1.40 | 1.45 |
| b | 0.30 | 0.37 | 0.45 |
| c | 0.09 | -- | 0.20 |
| D | 9.00 BASIC | | |
| D1 | 7.00 BASIC | | |
| D2 | 5.60 Ref. | | |
| E | 9.00 BASIC | | |
| E1 | 7.00 BASIC | | |
| E2 | 5.60 Ref. | | |
| e | 0.80 BASIC | | |
| L | 0.45 | 0.60 | 0.75 |
| θ | 0° | -- | 7° |
| ccc | -- | -- | 0.10 |

Reference Document: JEDEC Publication 95, MS-026



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TABLE 9. ORDERING INFORMATION

| Part/Order Number | Marking | Package | Shipping Packaging | Temperature |
|-------------------|--------------|--------------------------|--------------------|---------------|
| 87951AYI | ICS87951AYI | 32 Lead LQFP | tube | -40°C to 85°C |
| 87951AYIT | ICS87951AYI | 32 Lead LQFP | 1000 tape & reel | -40°C to 85°C |
| 87951AYILF | ICS87951AYIL | 32 Lead "Lead-Free" LQFP | tube | -40°C to 85°C |
| 87951AYILFT | ICS87951AYIL | 32 Lead "Lead-Free" LQFP | 1000 tape & reel | -40°C to 85°C |

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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| REVISION HISTORY SHEET | | | | |
|------------------------|-------|------|--|----------|
| Rev | Table | Page | Description of Change | Date |
| B | T1 | 3 | Pin Description Table - revised MR/nOE description. | 7/10/03 |
| | T2 | 3 | Pin Characteristics Table - changed C_{IN} 4pf max. to 4pf typical. Added R_{OUT} row. | |
| | | 5 | DC Characteristics - changed V_{IH} CLK0 from 3.6V max to $V_{DD} + 0.3V$ and added V_{IL} CLK0 row. | |
| | | 8 | Updated Single Ended Signal Driving Differential Input diagram. | |
| | | 9 | Added CLK/nCLK Input Interface section. | |
| | T9 | 1 | Features Section - added lead-free bullet. | 11/23/05 |
| | | 9 | Added <i>Recommendations for Unused Input and Output Pins</i> . | |
| | | 12 | Ordering Information Table - added lead-free part number, marking, and note. | |
| C | T9 | 12 | Updated datasheet's header/footer with IDT from ICS. | 7/17/10 |
| | | 14 | Removed ICS prefix from Part/Order Number column. Added Contact Page. | |



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We've Got Your Timing Solution.



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